XG-2121CA

Clock OSC

Product name XG-2121CA 402.832000MHz +/-100ppm LHPA

Product Number / Ordering code X1M0003510007xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LVDS

Pb free / Complies with EU RoHS directive

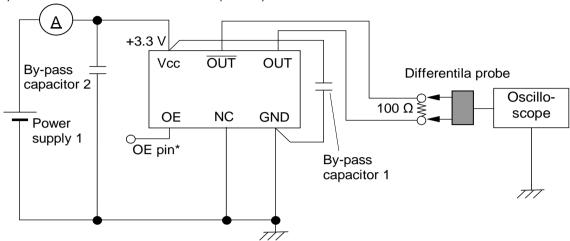
Reference weight Typ. 133 mg

1.Absolute maximum ratings								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks		
Maximum supply voltage	Vcc-GND	-0.5	-	4	V	-		
Storage temperature	T_stg	-55	-	125	٥C	Storage as single product		
Input voltage	Vin	-0.5	-	Vcc+0.5	V	OE Terminal		

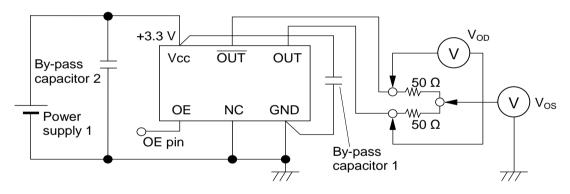
2.Specifications(character	istics)					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks
Output frequency	f0	-	402.8320	-	MHz	-
Supply voltage	Vcc	-0.5	-	4	V	-
Operating temperature	T_use	0	-	70	°C	-
Frequency tolerance	f_tol	-100	-	100	x10 ⁻⁶	-
Current consumption	Icc	-	-	30	mA	-
Stand-by current	I_std	-	-	-	mA	-
Disable current	I_dis	-	-	15.0	mA	-
Symmetry	SYM	45	-	55	%	-
Output voltage(LVDS)	Vod	247	-	454	mV	-
	dVod	-	-	50	mV	-
	Vos	1.125	-	1.375	V	-
	dVos	-	-	150	mV	-
Output load condition(LVDS)	L_LVDS	-	100	-	Ω	-
Input voltage	V _{IH}	0.7Vcc	-	-		-
	V _{IL}	-	-	0.3Vcc		-
Rise time	t _r	-	-	400	ps	-
Fall time	tf	-	-	400	ps	-
Start-up time	t_str	-	-	10	ms	-
Jitter	t _{DJ}	-	-	N/A	ps	Deterministic Jitter
	T _{RJ}	-	-	N/A	ps	Random Jitter
	t _{RMS}	-	-	N/A	ps	δ(RMS of total distribution)
	t _{p-p}	-	-	N/A	ps	Peak to Peak
	t _{acc}	-	-	N/A	ps	Accumulated Jitter(δ) n=2 to 50000 cycles
Phase jitter	t _{PJ}	-	-	0.16	ps	Off set Frequency: 12kHz to 20MHz
Phase noise	L(f)	-	-	-	dBc/Hz	Off set 1Hz
		-	-50.7	-	dBc/Hz	Off set 10Hz
		-	-74.6	-	dBc/Hz	Off set 100Hz
		-	-101.3	-	dBc/Hz	Off set 1kHz
		-	-133.9	•	dBc/Hz	Off set 10kHz
		-	-144.9	-	dBc/Hz	Off set 100kHz
		-	-147.7	-	dBc/Hz	Off set 1MHz
Frequency aging	f_age	-	-	-	x10 ⁻⁶ /Year	Included in Frequency tolerance 10 years
			-			<u> -</u>

3.Test circuit

1) To observe waveform and current (case 1)



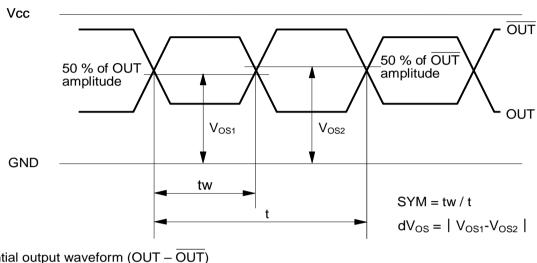
- * The lines from OUT and OUT pin are same length.
- * To measure the disable current, OE pin is connected to GND
- 2) To observe waveform and current (case 2)

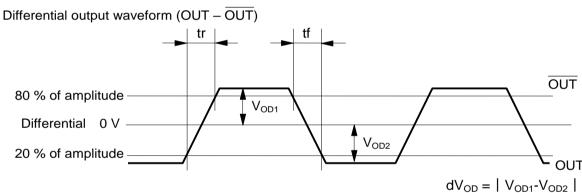


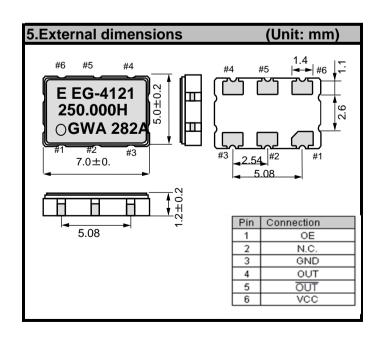
- * The lines from OUT and OUT pin are same length.
- 3) Measurement condition
- A) Oscilloscope
- •Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).
- •Probe ground should be placed closely from test point and lead length should be as short as possible.
- B) By-pass capacitor 1 (approx. 0.01 μF to 0.1 μF) places closely between Vcc and GND.
- C) By-pass capacitor 2 (approx. 10 µF) places closely between power supply terminals on the board.
- D) Use the current meter whose internal impedance value is small.
- E) Power supply
- Start up time (0 Vg90 %Vcc) of power source should be more than 150 μ s and slew rate should be less than 19.8 mV/ μ s.
- Impedance of power supply should be as low as possible.

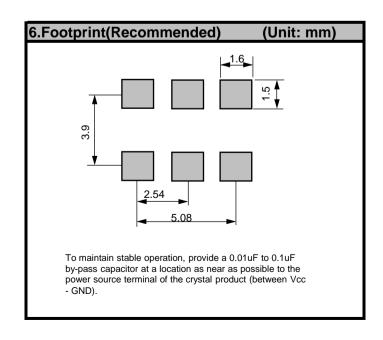
4.Timing chart

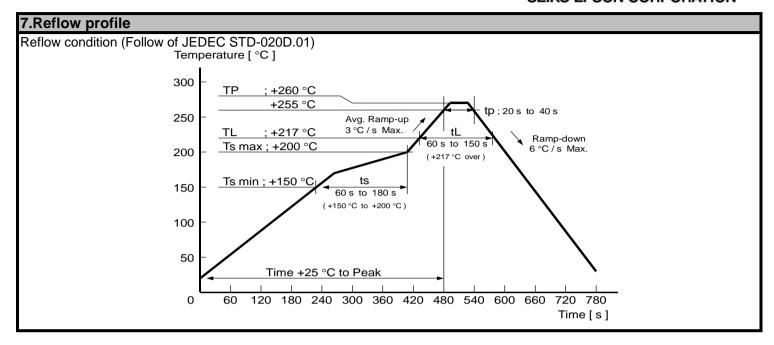
Each output waveform (OUT, and OUT)



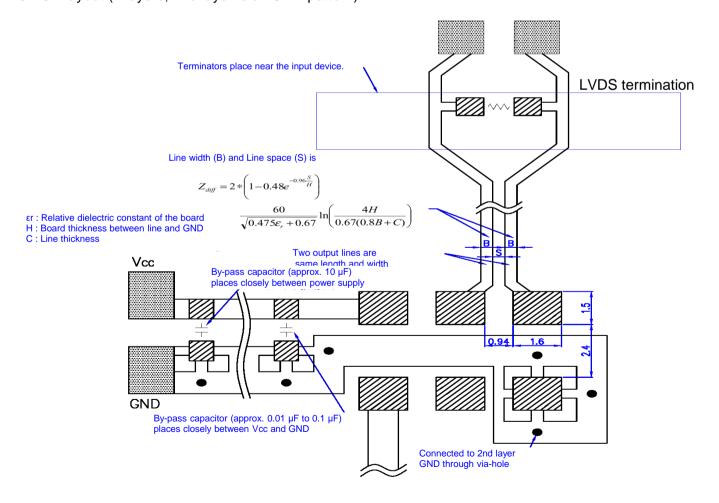








8.PCB layout (2 layers, 2nd layer is all GND pattern)



- * By-pass capacitor (approx. 0.01 µF to 0.1 µF) places closely between Vcc and GND.
- * By-pass capacitor (approx. 10 µF) places closely between power supply terminals on the board.
- * Please design the two output lines by characteristic impedance 100 Ω and same length, and try to make the output lines as short as possible.

9.Packing	g imorma	ILIOII		
[1]Produc	t number l	ast 2 digits code(xx) description		The recommended code is "00"
	X1M000	3510007xx		
	Code	Condition	Code	Condition
	01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel
	11	Any Q'ty / Reel	00	1000pcs / Reel
	12	250pcs / Reel		

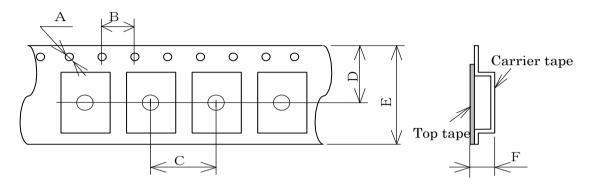
[2] Taping specification Subject to EIA-481 & IEC-60286

(1) Tape dimensions

Material of the Carrier Tape : PS

Material of the Top Tape : PET+PE

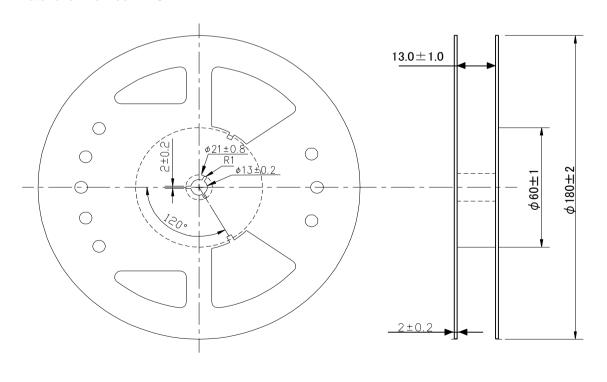
Unit: mm



Symbol	Α	В	С	D	Е	F
Value	φ1.5	4	8	9.25	16	2.3

(2) Reel dimensions

Center material : PS Material of the Reel : PS



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